

2A 23V Synchronous Step-Down Converter

FEATURES

- 2A Continuous Output Current
- Programmable Soft Start
- 130mΩ Internal Power MOSFET Switches
- Stable with Low ESR Output Ceramic Capacitors
- Up to 93% Efficiency
- $1\mu\text{A}$ Supply Current in Shutdown Mode
- Fixed 340KHz Frequency
- Thermal Shutdown
- Cycle by Cycle Over Current Protection
- Wide 4.75 to 23V Operating Input Range
- Output Adjustable from 0.925V to 12V
- Under Voltage Lockout

APPLICATIONS

- Networking Systems such as Modems & Routers
- Distributed Power Systems
- Pre-Regulator for Linear Regulators.
- Set-top Box

DESCRIPTION

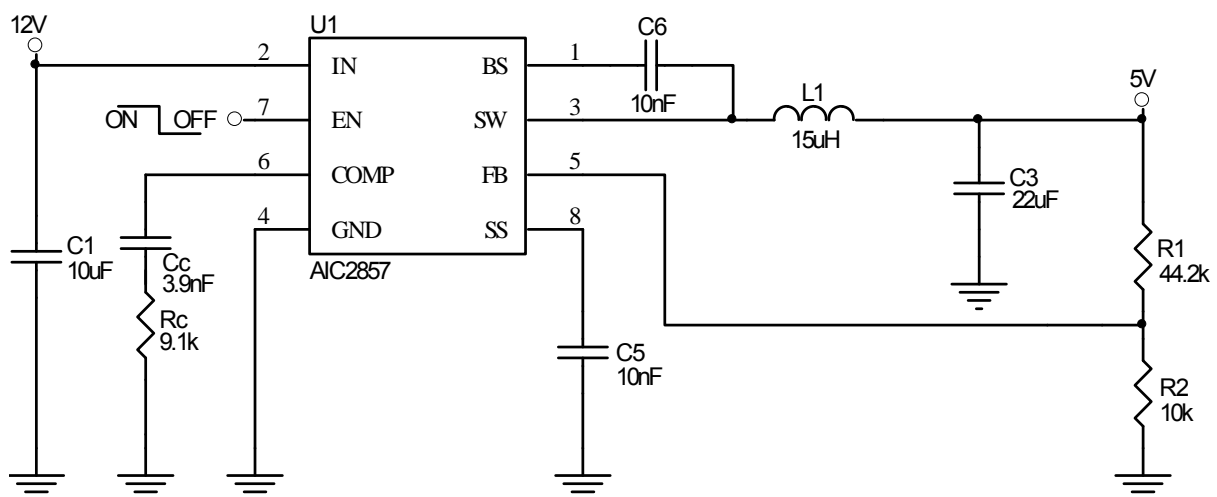
The AIC2857 is a synchronous step-down regulator with an integrated Power MOSFET. It achieves 2A continuous output current over a wide input supply range with excellent load and line regulation.

Current mode operation provides fast transient response and eases loop stabilization.

Fault condition protection includes cycle-by-cycle current limiting and thermal shutdown. Adjustable soft-start reduces the stress on the input source and the output overshoot at turn-on. In shutdown mode, the regulator draws $1\mu\text{A}$ or less of supply current.

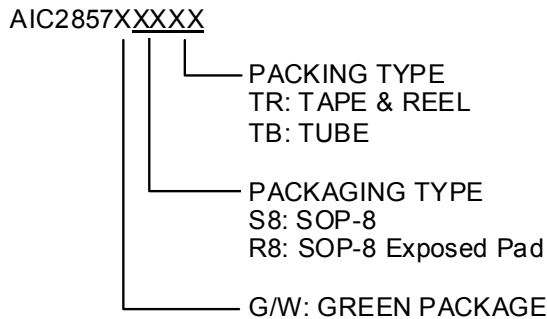
The AIC2857 is available in SOP8 and SOP-8 with Exposed Pad Package.

TYPICAL APPLICATIONS CIRCUIT



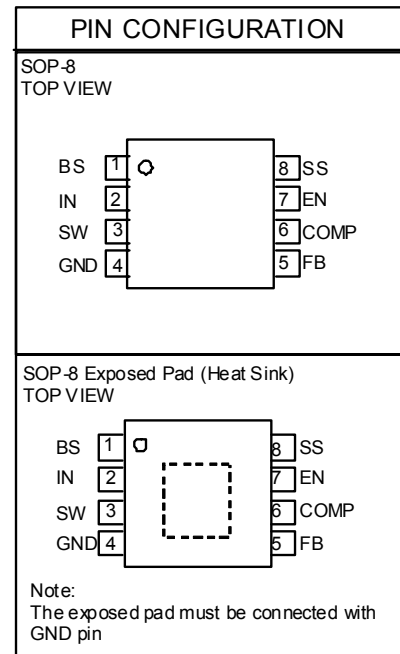
Typical Application Circuit

ORDERING INFORMATION



Example:

AIC2857GR8TR
 → GREEN SOP-8 Exposed Pad (Heat Sink) Package and TAPE & REEL Packing Type



ABSOLUTE MAXIMUM RATINGS

| | |
|--|----------------------------------|
| Input Voltage (V_{IN})..... | -0.3V to 26V |
| SW pin Voltage (V_{SW})..... | -1V to $V_{IN} + 0.3V$ |
| BS Pin Voltage | $V_{SW} - 0.3V$ to $V_{SW} + 6V$ |
| EN Pin Voltage | -0.3V to V_{IN} |
| All Other Pins Voltage | -0.3V to 6V |
| Operating Ambient Temperature Range T_A | -40°C~85°C |
| Operating Maximum Junction Temperature T_J | 150°C |
| Storage Temperature Range T_{STG} | -65°C~150°C |
| Lead Temperature (Soldering 10 Sec.) | 260°C |
| Thermal Resistance Junction to Case | |
| SOP-8 | 40°C/W |
| SOP-8 Exposed Pad* | 15°C/W |
| Thermal Resistance Junction to Ambient | |
| SOP-8 | 160°C/W |
| SOP-8 Exposed Pad* | 60°C/W |

(Assume no Ambient Airflow)

Absolute Maximum Ratings are those values beyond which the life of a device may be impaired.

*The package is place on a two layers PCB with 2 ounces copper and 2 square inch, connected by 8 vias.

ELECTRICAL CHARACTERISTICS
($V_{IN}=12V$, $V_{EN}=5V$, $T_A=25^{\circ}C$, unless otherwise specified.) (Note1)

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS |
|--|---------------|---------------------------------|------|-------|-------|-------------|
| Shutdown Supply Current | | $V_{EN} = 0V$ | | 0.3 | 3 | μA |
| Supply Current | | $V_{FB} = 1.0V$ | | 1.3 | 1.5 | mA |
| Feedback Voltage | V_{FB} | $4.75V \leq V_{IN} \leq 23V$ | 0.90 | 0.925 | 0.950 | V |
| Feedback Overvoltage Threshold | | | | 1.1 | | V |
| Error Amplifier Voltage Gain | A_{EA} | | | 400 | | V/V |
| Error Amplifier Transconductance | G_{EA} | $\Delta I_{COMP} = \pm 10\mu A$ | | 820 | | $\mu A/V$ |
| High-Side Switch On-Resistance | $R_{DS(ON)1}$ | | | 130 | | m Ω |
| Low-Side Switch On-Resistance | $R_{DS(ON)2}$ | | | 130 | | m Ω |
| High-Side Switch Leakage Current | | $V_{EN} = 0V$, $V_{SW} = 0V$ | | 0 | 10 | μA |
| Upper Switch Current Limit | | Minimum Duty Cycle | 2.7 | 3.4 | | A |
| Lower Switch Current Limit | | From Drain to Source | | 0.9 | | A |
| COMP to Current Sense Transconductance | G_{CS} | | | 5.2 | | A/V |
| Oscillation Frequency | f_{OSC} | | 300 | 340 | 380 | KHz |
| Short Circuit Oscillation Frequency | | $V_{FB} = 0V$ | | 110 | | KHz |
| Maximum Duty Cycle | D_{MAX} | $V_{FB} = 0.8V$ | | 90 | | % |
| Minimum On Time | T_{ON} | | | 220 | | ns |
| EN Shutdown Threshold Voltage | | V_{EN} Rising | 1.1 | 1.5 | 2.2 | V |
| EN Shutdown Threshold Voltage Hysteresis | | | | 220 | | mV |
| Under Voltage Lockout Threshold | | V_{IN} Rising | 3.7 | 4.1 | | V |
| Under Voltage Lockout Threshold Hysteresis | | | | 210 | | mV |
| Soft-Start Current | | $V_{SS} = 0V$ | | 6 | | μA |
| Soft-Start Period | | $C_{SS} = 0.1\mu F$ | | 15 | | ms |
| Thermal Shutdown | | | | 160 | | $^{\circ}C$ |

Note 1: Specifications are production tested at $T_A=25^{\circ}C$. Specifications over the $-40^{\circ}C$ to $85^{\circ}C$ operating temperature range are assured by design, characterization and correlation with Statistical Quality Controls (SQC).

Note 2: It is recommended to use duty ratio above 10% for minimizing resultant duty cycle jitter.

Note 3: It is recommended to connect a soft start capacitor to soft start pin. Leave the soft start pin open may cause large inrush current and output overshooting.

TYPICAL PERFORMANCE CHARACTERISTICS

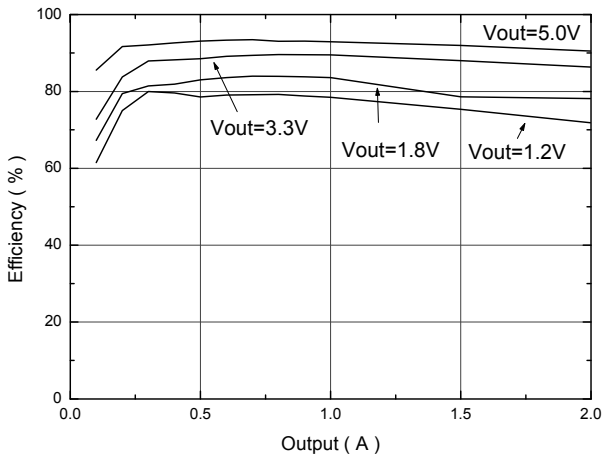


Fig. 1 Efficiency vs. Load Current at $V_{IN} = 12V$

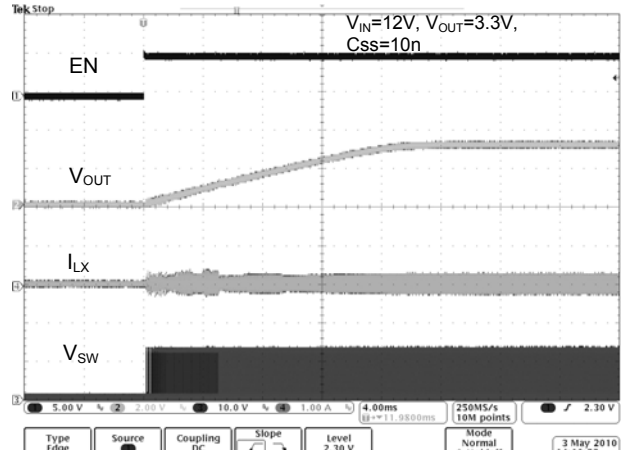


Fig. 2 Start-Up Waveform at $V_{OUT}=3.3V, I_{OUT}=0A$

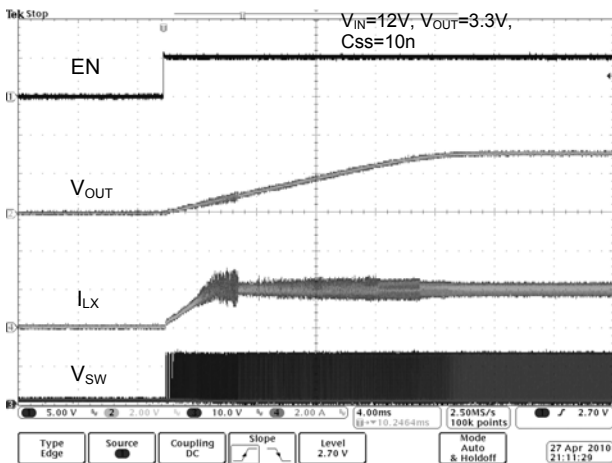


Fig. 3 Start-Up Waveform at $V_{OUT}=3.3V, I_{OUT}=2A$

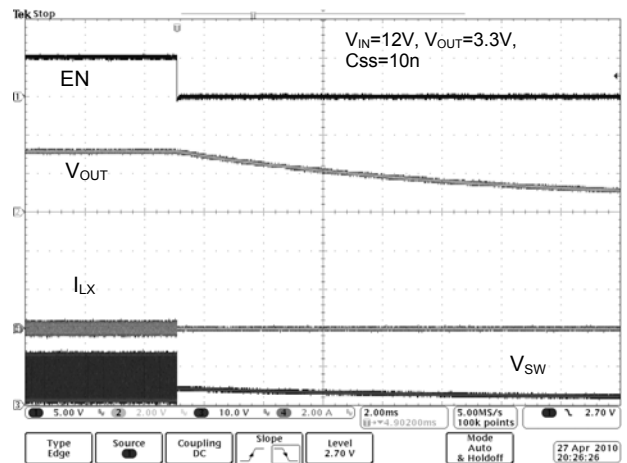


Fig. 4 Shutdown Waveform at $V_{OUT}=3.3V, I_{OUT}=0A$

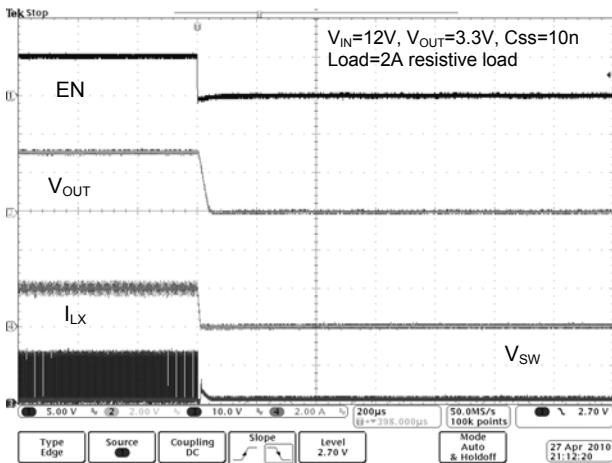


Fig. 5 Shutdown Waveform at $V_{OUT}=3.3V, I_{OUT}=2A$

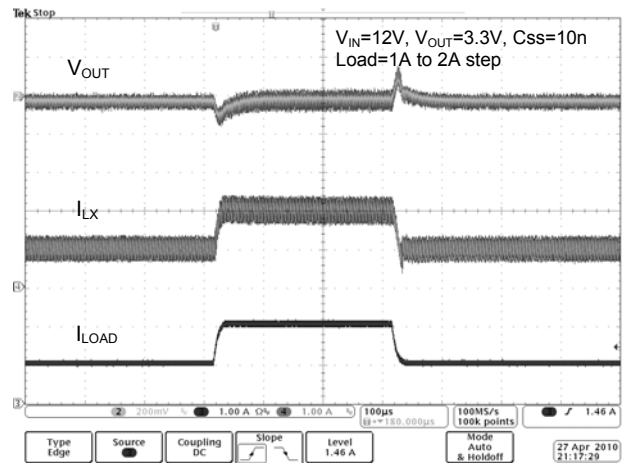


Fig. 6 Load Transient at $V_{OUT}=3.3V, I_{OUT}=1A$ to $2A$

TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

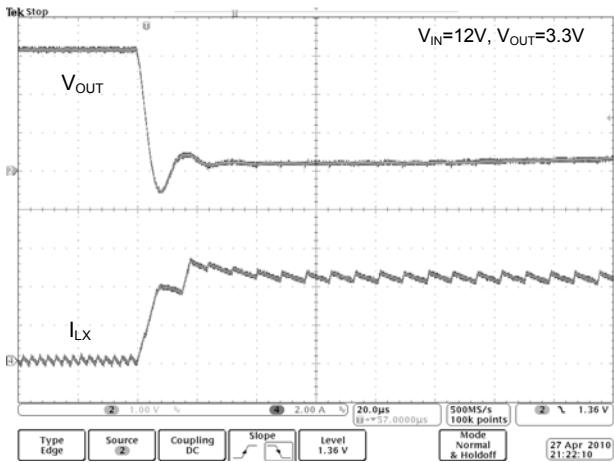


Fig. 7 Short Circuit Waveforms

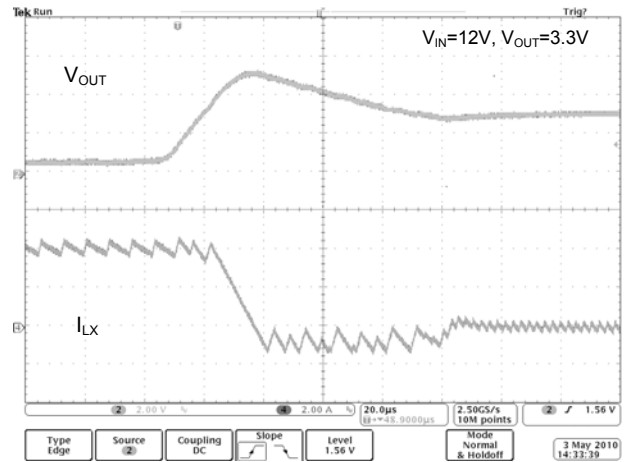


Fig. 8 Short Circuit Recovery Waveforms

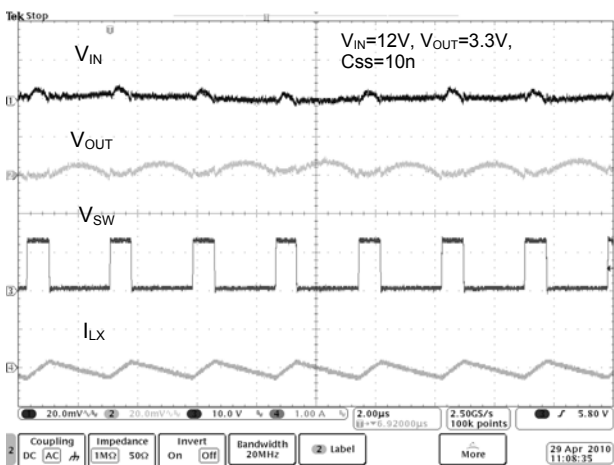


Fig. 9 Stability Waveform at $V_{OUT}=3.3V$, $I_{OUT}=0A$

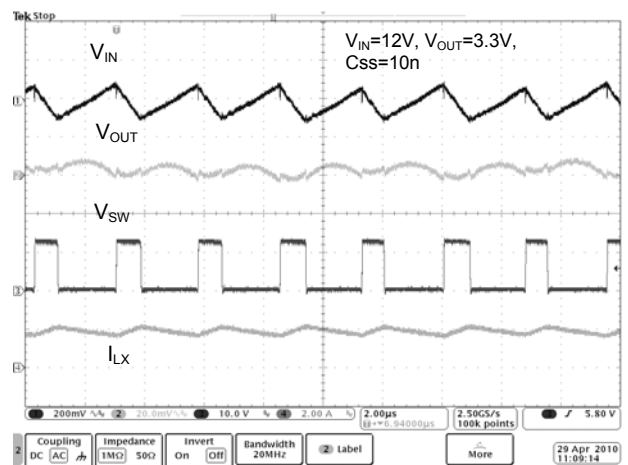
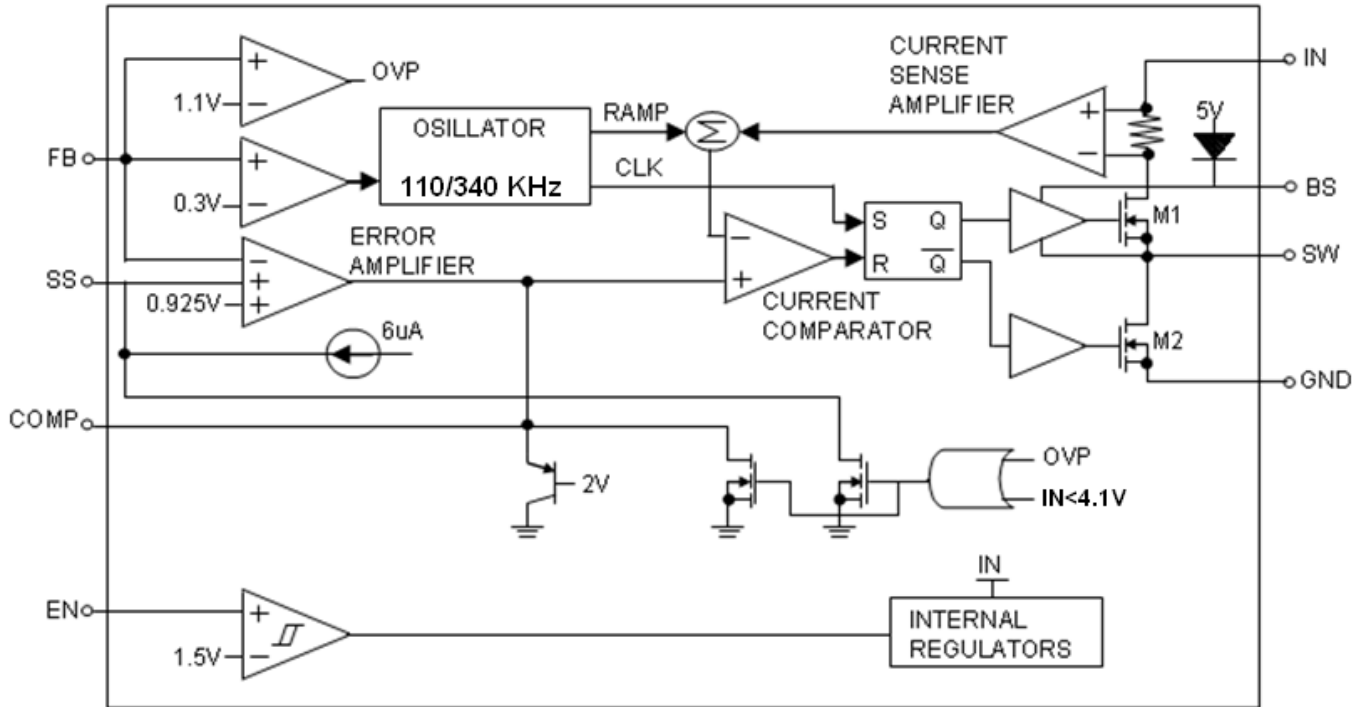


Fig. 10 Stability Waveform at $V_{OUT}=3.3V$, $I_{OUT}=2A$

■ BLOCK DIAGRAM



Functional Block Diagram of AIC2857

■ PIN DESCRIPTIONS

- Pin 1: BS: High Side Gate Drive Boost Input. BS supplies the drive for the high-side N-Channel MOSFET switch. Connect a 10nF or greater capacitor from SW to BS to power the high-side switch.
- Pin 2: IN: Power Input. IN supplies the power to the IC, as well as the step-down converter switches. Drive IN with a 4.75 to 23V power source. Bypass IN to GND with a suitably large capacitor to eliminate noise on the input to the IC.
- Pin 3: SW: Power Switching Output. SW is the switching node that supplies power to the output. Connect the output LC filter from switch to the output load. Note that a capacitor is required from SW to BS to power the high-side switch.
- Pin 4: GND: Ground. Connect the exposed pad on backside to Pin 4.
- Pin 5: FB: Feedback Input. FB senses the output voltage to regulate that voltage. Drive feedback with a resistive voltage divider from the output voltage.
- Pin 6: COMP: Compensation Node. COMP is used to compensate the regulation control loop. Connect a series RC network from COMP to GND to compensate the regulation control loop. In some cases, an additional capacitor from COMP to GND is required.
- Pin 7: EN: Enable Input. EN is a digital input that turns the regulator on or off. Drive EN high to turn on the regulator. Drive it low to turn it off. For automatic start-up, attach to IN with a 100k Ω pull up resistor.
- Pin 8: SS: Soft Star Control Input. SS controls the soft star period. Connect a capacitor from SS to GND to set the soft-star period. A 0.1 μ F capacitor sets the soft-star period to 15ms.

■ APPLICATION INFORMATIONS

The AIC2857 is a synchronous high voltage buck converter that can support the input voltage range from 4.75V to 23V and the output current can be up to 2A.

Setting the Output Voltage

The output voltage is set using a resistive voltage divider connected from the output voltage to FB. The voltage divider divides the output voltage down to the feedback voltage by the ratio:

$$V_{FB} = V_{OUT} \frac{R2}{R1 + R2}$$

Thus the output voltage is:

$$V_{OUT} = 0.925 \times \frac{R1 + R2}{R2}$$

For example, for a 3.3V output voltage, R2 is 10kΩ, and R1 is 26.1kΩ.

Inductor

The inductor selection depends on the current ripple of inductor, the input voltage, and the output voltage.

$$L \geq \frac{V_{OUT}}{f_{OSC} \cdot \Delta I_L} \left(1 - \frac{V_{OUT}}{V_{IN}} \right)$$

Accepting a large current ripple of inductor allows the use of a smaller inductance. However, higher current ripple of inductor can cause higher output ripple voltage and large core loss. By setting an acceptable current ripple of inductor, a suitable inductance can be obtained from above equation.

In addition, it is important to ensure the inductor saturation current exceeds the peak value of inductor current in application to prevent core saturation. The peak value of inductor current can be calculated according to the following equation.

$$I_{PEAK} = I_{OUT(max)} + \frac{V_{OUT}}{2 \times f_{OSC} \cdot L} \left(1 - \frac{V_{OUT}}{V_{IN}} \right)$$

Soft-Start

The AIC2857 provides the soft-start function. Initially, the voltage at SS pin is 0V. Then an internal current source of 6μA (typ.) charges an external soft-start capacitor. During the soft-start period, the voltage at SS pin will limit the feedback threshold voltage at FB pin. When the voltage at SS pin is higher than 0.925V, the feedback threshold voltage at FB pin reaches the desired value. The soft-start time can be calculated in accordance with the following equation.

$$t_{ss} = C5 \times \frac{0.925V}{6\mu A}$$

The soft-start capacitor is discharged to GND when the EN pin is connected to GND.

Optional Schottky Diode

A Schottky diode with low forward drop voltage and fast reverse recovery is the ideal choice for better efficiency. The forward drop voltage of a Schottky diode will result in the conduction losses in the diode, and the diode capacitance (C_T or C_D) will cause the switching losses. Therefore, it is necessary to consider both forward voltage drop and diode capacitance for diode selection. In addition, the rating of selected Schottky diode should be able to handle the input voltage and the maximum peak diode current.

Input Capacitor and Output Capacitor

To prevent the high input voltage ripple and noise resulted from high frequency switching, the use of low ESR ceramic capacitor for the maximum RMS current is recommended. The approximated RMS current of the input capacitor can be calculated according to the following equation.

$$I_{CINRMS} \approx \sqrt{I_{OUT(MAX)}^2 \times \frac{V_{OUT}(V_{IN} - V_{OUT})}{V_{IN}^2} + \frac{\Delta I_L^2}{12}}$$

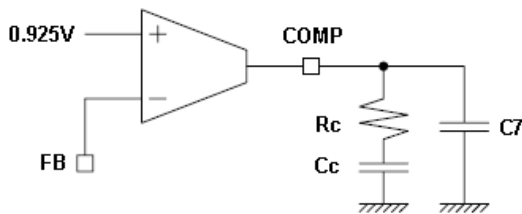
The selection of output capacitor depends on the required output voltage ripple. The output voltage ripple can be expressed as:

$$\Delta V_{OUT} = \frac{\Delta I_L}{8 \times f_{OSC} \times C3} + ESR \Delta I_L$$

For lower output voltage ripple, the use of low ESR ceramic capacitor is recommended. The tantalum capacitor can also be used well, but its ERS is larger than that of ceramic capacitor.

When choosing the input and output ceramic capacitors, X5R and X7R types are recommended because they retain their capacitance over wider ranges of voltage and temperature than other types.

Loop Compensation



In order to avoid the poor output voltage ripple and low efficiency caused by instability, AIC2857 requires a proper external compensation network to compensate its feedback loop. In this external compensation network, the compensation resistor, R_C , and the compensation capacitor, C_C , are used to set the high-frequency integrator gain and the integrator zero. $C7$ is used to cancel the zero caused by the output capacitor and its ESR. While using the ceramic capacitor as the output capacitor, $C7$ can be omitted due to the small ESR.

The system has one pole of importance, due to the output capacitor, $C3$ and the load resistor. This poles is located at:

$$F_{P1} = \frac{1}{2\pi \times C3 \times R_{LOAD}}$$

The system has one zero of importance, due to the compensation capacitor, Cc and the compensation resistor, Rc . This zero is located at:

$$F_{Z1} = \frac{1}{2\pi \times Cc \times Rc}$$

The system may have another zero of importance, if the output capacitor has a large capacitance and/or a high ESR value. The zero, due to the ESR and capacitance of the output capacitor, is located at:

$$F_{ESR} = \frac{1}{2\pi \times C3 \times R_{ESR}}$$

In this case, a third pole set by the compensation capacitor, $C7$ and the compensation resistor, Rc is used to compensate the effect of the ESR zero on the loop gain. This pole is located at:

$$F_{P2} = \frac{1}{2\pi \times C7 \times Rc}$$

The values of the compensation components given in this data sheet yield a stable control loop for the given output voltage and capacitor. If different conversions and output capacitors are requires, some values of the compensation components may need to be adjusted to ensure stability.

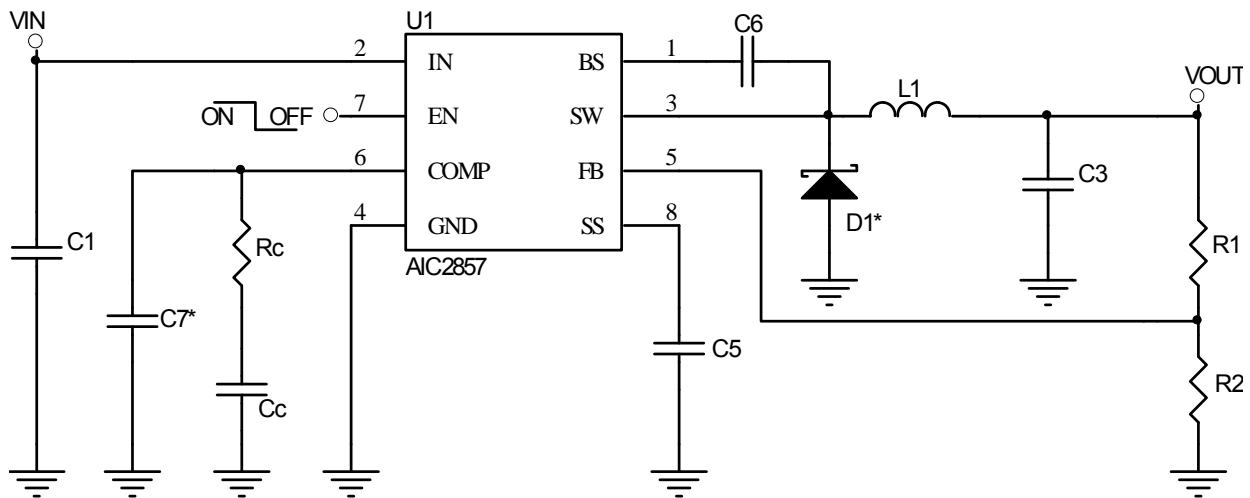
Layout Consideration

In order to ensure a proper operation of AIC2857, the following points should be managed comprehensively.

1. The input capacitor and V_{IN} should be placed as close as possible to each other to reduce the input voltage ripple and noise.
2. The output loop, which is consisted of the inductor, the internal power switch, the Schottky diode and the output capacitor, should be kept as small as possible.
3. The routes with large current should be kept short and wide.

4. Logically the large current on the converter should flow at the same direction.
5. In order to prevent the effect from noise, the IC's GND pin should be placed close to the ground of the input bypass capacitor.
6. The FB pin should be connected to the feedback resistors directly and the route should be away from the noise sources.

APPLICATION CIRCUIT



* Note: Optional D1 may be paralleled between the SW pin and GND pin to improve overall efficiency.

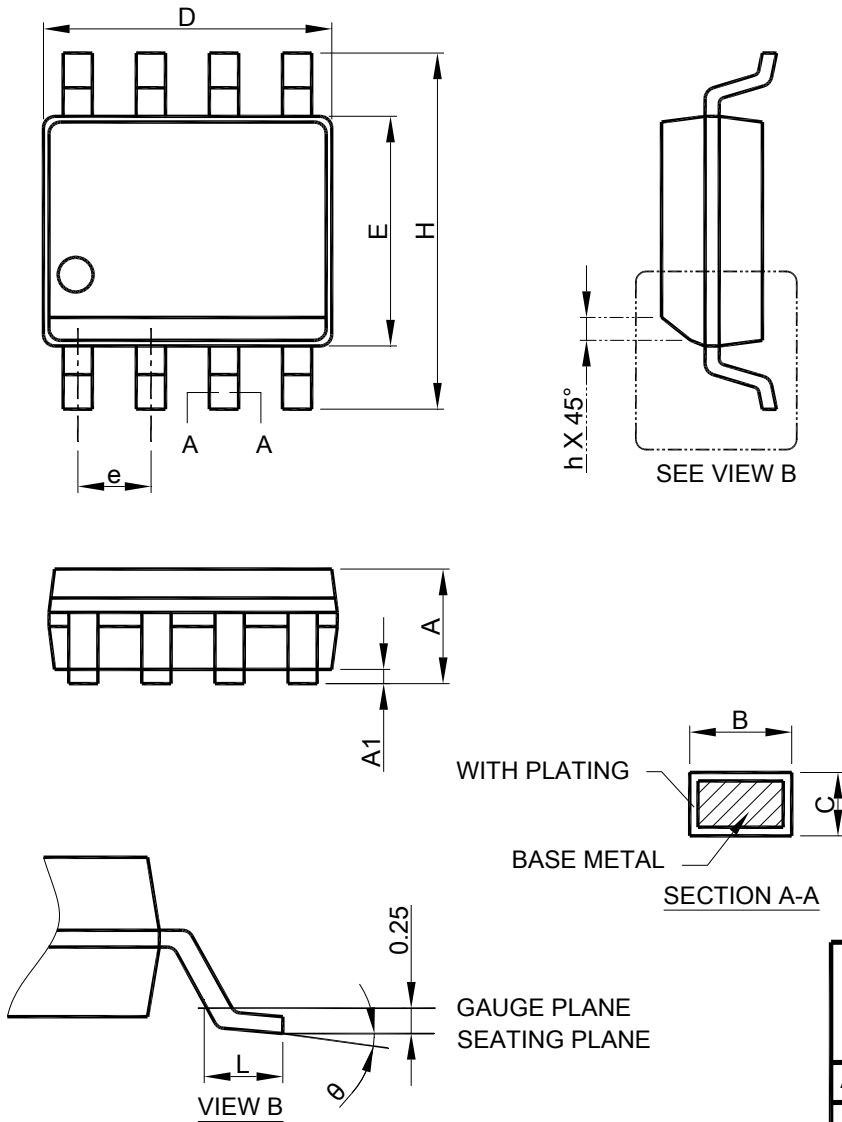
** Note: C7 is needed for high ESR output capacitor

COMPONENT SELECTION

| V _{IN} (V) | V _{OUT} (V) | L (μH) | C _{OUT} (μF) | R _c (kΩ) | C _c (nF) | C7 (pF) |
|---------------------|----------------------|-------------------------------|--|---------------------|---------------------|---------|
| 12 | 1.2 | 4.7 (Taiyo Yuden NR8040T4R7N) | 22 ceramic (Taiyo Yuden EMK325BJ226MM-T) | 4.7 | 12 | None |
| 12 | 1.8 | 6.8 (Lee Yu LYB1207-6R8) | 22 ceramic (Taiyo Yuden EMK325BJ226MM-T) | 1.2 | 8.2 | None |
| 12 | 3.3 | 10 (COOPER Bussmann DR125) | 22 ceramic (Taiyo Yuden EMK325BJ226MM-T) | 1.2 | 4.7 | None |
| 12 | 5.0 | 15 (Lee Yu LYS104S-150M) | 22 ceramic (Taiyo Yuden EMK325BJ226MM-T) | 9.1 | 3.9 | None |

■ PHYSICAL DIMENSIONS

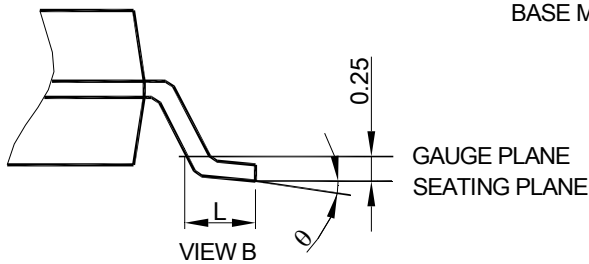
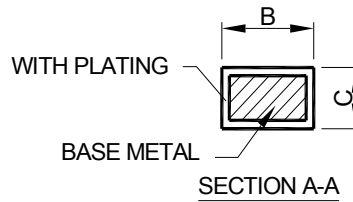
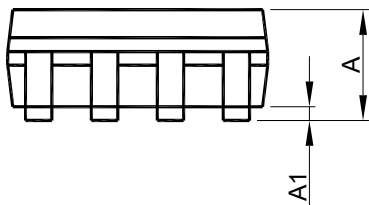
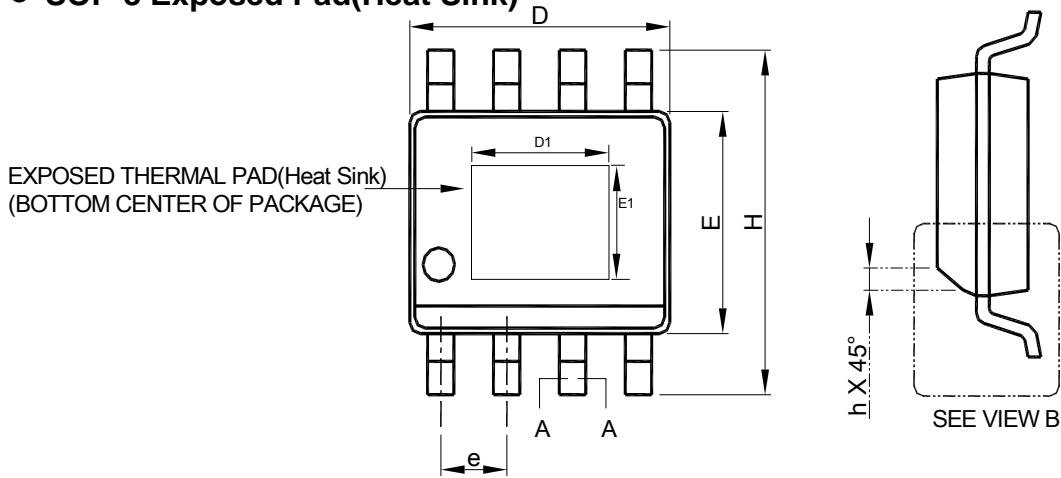
● SOP-8



- Note: 1. Refer to JEDEC MS-012AA.
 2. Dimension "D" does not include mold flash, protrusions or gate burrs. Mold flash, protrusion or gate burrs shall not exceed 6 mil per side .
 3. Dimension "E" does not include inter-lead flash or protrusions.
 4. Controlling dimension is millimeter, converted inch dimensions are not necessarily exact.

| SYMBOL | SOP-8 | |
|----------|-------------|------|
| | MILLIMETERS | |
| | MIN. | MAX. |
| A | 1.35 | 1.75 |
| A1 | 0.10 | 0.25 |
| B | 0.33 | 0.51 |
| C | 0.19 | 0.25 |
| D | 4.80 | 5.00 |
| E | 3.80 | 4.00 |
| e | 1.27 BSC | |
| H | 5.80 | 6.20 |
| h | 0.25 | 0.50 |
| L | 0.40 | 1.27 |
| θ | 0° | 8° |

● SOP-8 Exposed Pad(Heat Sink)



| SYMBOL | SOP-8 Exposed Pad(Heat Sink) | |
|--------|------------------------------|------|
| | MILLIMETERS | |
| | MIN. | MAX. |
| A | 1.35 | 1.75 |
| A1 | 0.00 | 0.15 |
| B | 0.31 | 0.51 |
| C | 0.17 | 0.25 |
| D | 4.80 | 5.00 |
| D1 | 1.50 | 3.50 |
| E | 3.80 | 4.00 |
| E1 | 1.0 | 2.55 |
| e | 1.27 BSC | |
| H | 5.80 | 6.20 |
| h | 0.25 | 0.50 |
| L | 0.40 | 1.27 |
| θ | 0° | 8° |

- Note :
1. Refer to JEDEC MS-012E.
 2. Dimension "D" does not include mold flash, protrusions or gate burrs. Mold flash, protrusion or gate burrs shall not exceed 6 mil per side .
 3. Dimension "E" does not include inter-lead flash or protrusions.
 4. Controlling dimension is millimeter, converted inch dimensions are not necessarily exact.

Note:

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